

(V) Preliminary Specifications() Final Specifications

Module	14.0"(13.97") HD 16:9 Color TFT-LCD with LED Backlight design
Model Name	B140XW04 V0 (H/W:0A) .
Note (<table-cell-rows>)</table-cell-rows>	LED Backlight with driving circuit design

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Note: This Specification is subject to change without notice.			NBBU Market AU Optronics	ing Division s corporation



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Record of Revision

Vei	Version and Date Page		Old description	New Description	Remark
0.1	2010/11/29	All	First Edition for Customer		



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



2. General Description

B140XW04 v0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the 16:9 HD, 1366(H) x768(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B140XW01 V8 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit	Specifications					
Screen Diagonal	[mm]	354.95					
Active Area	[mm]	309.4 X173.95					
Pixels H x V		1366x3(RG	B) x 768				
Pixel Pitch	[mm]	0.2265X0.2	2265				
Pixel Format		R.G.B. Ver	tical Stripe				
Display Mode		Normally W	/hite				
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m ²]	200 typ. (5 points average) 170 min. (5 points average)					
Luminance Uniformity		1.25 max. ((5 points)				
Contrast Ratio		500 typ					
Response Time	[ms]	16 typ					
Nominal Input Voltage VDD	[Volt]	+3.3 typ.					
Power Consumption	[Watt]	TBD max.	(Include Log	gic and Blu p	oower)		
Weight	[Grams]	350 max.					
Physical Size	[mm]		Min.	Тур.	Max.		
Include bracket		Length			324		
		Width			192.5		
		Thickness			5.2		
Electrical Interface		1 channel l	_VDS				
Glass Thickness	[mm]	0.5					
Surface Treatment		Glare, Hardness 3H,					
Support Color		262K colors	s (RGB 6-b	it)			



Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

Item		Symbol	Conditions		Min.	Тур.	Max.	Unit	Note
White Lumin			5 points avera	ge	170	200	-	cd/m ²	1, 4, 5.
Viensie v Annala		θR θL	Horizontal (R CR = 10 (Le	ight) eft)	40 40	45 45	-	degree	
Viewing Ar	igie	ф н ф ∟	Vertical (Up CR = 10 (Low	per) ver)	10 30	15 35			4, 9
Luminan Uniformi		δ _{5P}	5 Points		-	-	1.25		1, 3, 4
	Luminance δ_{13P} 13 Points			-	-	1.50		2, 3, 4	
Contrast R	atio	CR	CR		400	500	-		4, 6
Cross ta	Cross talk						4		4, 7
		Tr	Rising		-				
Response 1	Гime	T _f	Falling		-	-		msec	4, 8
		T _{RT}	Rising + Falling		-	16	-		
	Red	Rx				TBD			
	neu	Ry				TBD			
	Green	Gx				TBD			
Color / Chromaticity	Green	Gy				TBD			
Coodinates	Dive	Bx	CIE 1931			TBD			4
	Blue	Ву				TBD			
	\ \ /\ _;;.	Wx			0.283	0.313	0.343		
	White	Wy			0.299	0.329	0.359		
NTSC		%			-	45	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

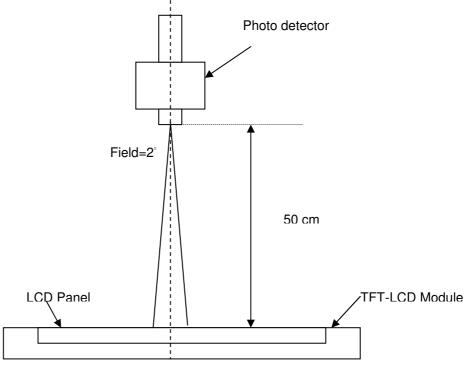
0	Maximum Brightness of five points
δ _{w5} =	Minimum Brightness of five points
2	Maximum Brightness of thirteen points
$\delta_{\text{W13}} =$	Minimum Brightness of thirteen points

Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Center of the screen

Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

Y_A = Luminance of measured location without gray level 0 pattern (cd/m₂)

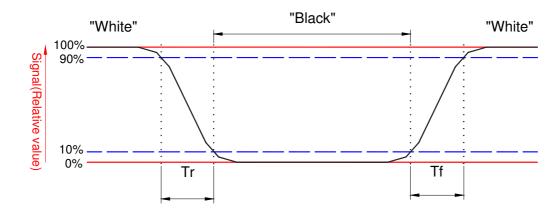
Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

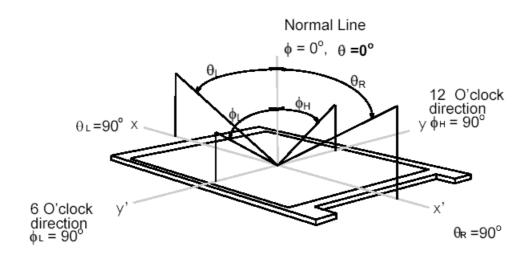




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Note 9. Definition of viewing angle

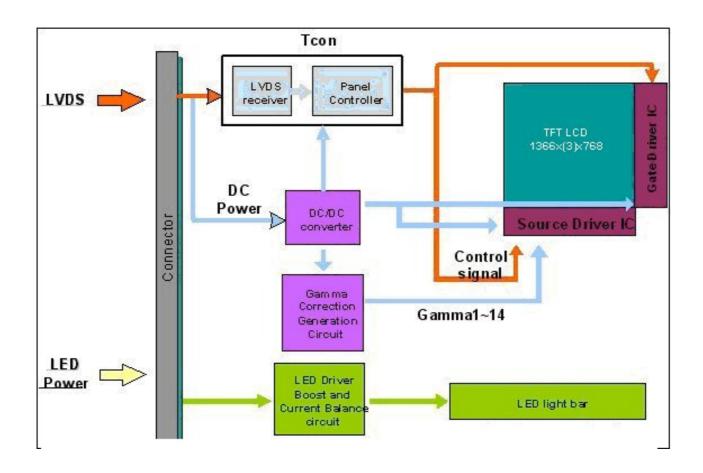
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 14.0 inches wide Color TFT/LCD 40 Pin one channel Module





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

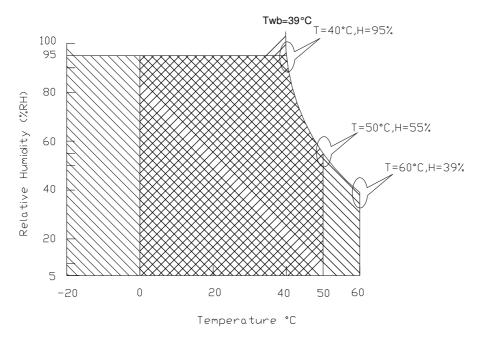
Item	Symbol	Min	Max	Unit	Conditions			
Operating Temperature	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	5	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

5. Electrical Characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

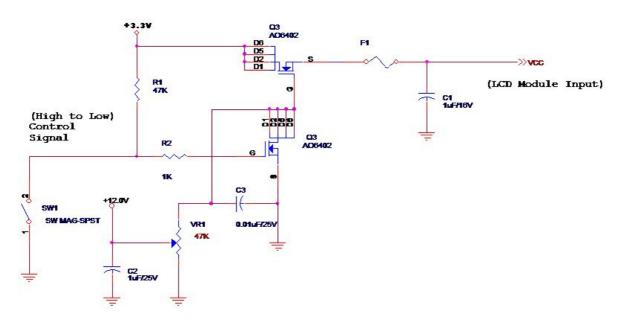
Input power specifications are as follows;

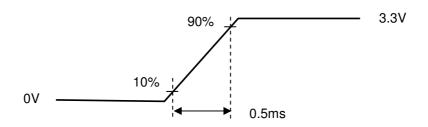
The power specification are measured under 25°C and frame frenquency under 60Hz

Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	_	0.8	1.0	[Watt]	Note 1
IDD	IDD Current	-	250	300	[mA]	Note 1
IRush	Inrush Current	-	-	2000	[mA]	Note 2
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1 : Maximum Measurement Condition : Black Pattern at 3.3V driving voltage. (P_{max}=V_{3.3} x I_{black})

Note 2: Measure Condition





Vin rising time



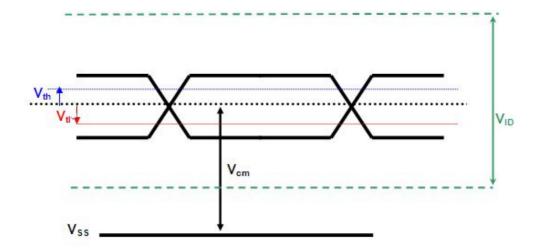
5.1.2 Signal Electrical Characteristics

Input signals shall be low or High-impedance state when VDD is off.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V_{th}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V _{tl}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V _{cm}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform





5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	-	TBD	[Watt]	(Ta=25°C), Note 1 Vin =12V
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25°C), Note 2
						I _F =20 mA

Note 1: Calculator value for reference P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Power Supply	VLED	6.0	12.8	21.0	[Volt]	
LED Enable Input High Level		2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	
PWM Logic Input High Level	VPWM EN	2.5	-	5.0	[Volt]	Define as
PWM Logic Input Low Level		-	-	0.8	[Volt]	Connector Interface
PWM Input Frequency	FPWM	700	1K	2K	Hz	(Ta=25°C)
PWM Duty Ratio	Duty	5		100	%	



6. Signal Interface Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1						13	66	5
1st Line	R G B	R G B		R	G	В	R	G	В
	1	,						`	
			•		i				
	,		1					` `	
			•						
	,		·					` `	
			:					`	
	1	'	1		•			•	
768th Line	R G B	R G B		R	G	В	R	G	В



6.2 The Input Data Format

RxCLKIN	N	
RxIN0	G0 R5 R4 R3 R2 R1 R	.0
RxIN1	B1 B0 G5 G4 G3 G2 G	1
RxIN2	DE VS HS B5 B4 B3 B	2

Signal Name	Description	
R5 R4 R3	Red Data 5 (MSB) Red Data 4 Red Data 3	Red-pixel Data Each red pixel's brightness data consists of these 6 bits pixel data.
R2 R1	Red Data 2 Red Data 1	these o bits pixel data.
R0	Red Data 0 (LSB)	
	Red-pixel Data	
G5 G4	Green Data 5 (MSB) Green Data 4	Green-pixel Data Each green pixel's brightness data consists of
G3 G2	Green Data 3 Green Data 2	these 6 bits pixel data.
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	Green-pixel Data	
B5 B4	Blue Data 5 (MSB) Blue Data 4	Blue-pixel Data Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2 B1	Blue Data 2 Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and DE signals. All pixel data shall be valid at the falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of RxCLKIN. When the signal is high, the pixel data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	JAE or compatible
Type / Part Number	HD1S040HA1 or compatible
Mating Housing/Part Number	PK24025P40

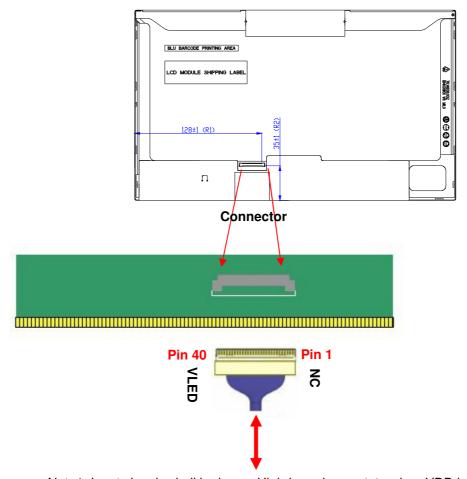
6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

PIN#	Signal Name	Description
1	NC	No Connection (Reserve)
2	VDD	Power Supply +3.3V
3	VDD	Power Supply +3.3V
4	VEDID	EDID +3.3V Power
5	NC	No Connect (Reserve)
6	CLK_EDID	EDID Clock Input
7	DAT_EDID	EDID Data Input
8	RxOIN0-	-LVDS Differential Data INPUT(Odd R0-R5,G0)
9	RxOIN0+	+LVDS Differential Data INPUT(Odd R0-R5,G0)
10	VSS	Ground
11	RxOIN1-	-LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
12	RxOIN1+	+LVDS Differential Data INPUT(Odd G1-G5,B0-B1)
13	VSS	Ground
14	RxOIN2-	-LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
15	RxOIN2+	+LVDS Differential Data INPUT(Odd B2-B5,HS,VS,DE)
16	VSS	Ground
17	RxOCKIN-	-LVDS Odd Differential Clock INPUT
18	RxOCKIN+	-LVDS Odd Differential Clock INPUT
19	VSS	Ground
20	NC	No connection
21	NC	No connection
22	vss	Ground



23	NC	No connection
24	NC	No connection
25	VSS	Ground
26	NC	No connection
27	NC	No connection
28	VSS	Ground
29	NC	No connection
30	NC	No connection
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
32 33		LED Ground
	VLED_GND	
33	VLED_GND VLED_GND	LED Ground
33 34	VLED_GND VLED_GND NC	LED Ground No Connection (Reserve)
33 34 35	VLED_GND VLED_GND NC S_PWMIN	LED Ground No Connection (Reserve) System PWM signal Input
33 34 35 36	VLED_GND VLED_GND NC S_PWMIN BL_ON	LED Ground No Connection (Reserve) System PWM signal Input LED enable pin(+3V input, +5V tolerance)
33 34 35 36 37	VLED_GND VLED_GND NC S_PWMIN BL_ON DBC_EN	LED Ground No Connection (Reserve) System PWM signal Input LED enable pin(+3V input, +5V tolerance) Dynamic B/L Control enable(High enable)



Note1: Input signals shall be low or High-impedance state when VDD is off.



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6.4 Interface Timing

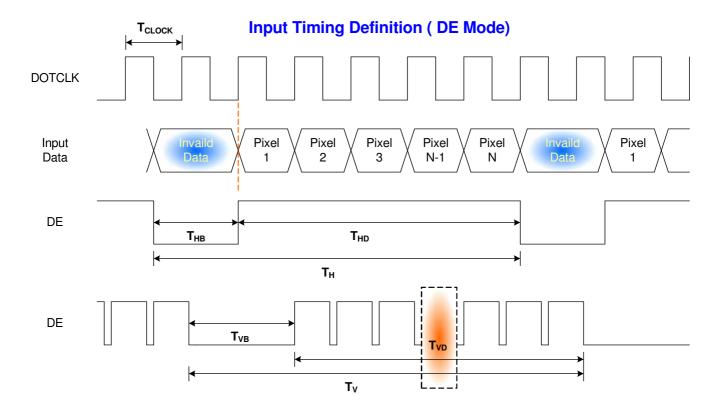
6.4.1 Timing Characteristics

Basically, interface timings should match the 1366x768 /60Hz manufacturing guide line timing.

Parai	neter	Symbol	Min.	Тур.	Max.	Unit	
Frame Rate		-	-	60	-	Hz	
Clock frequency		1/ T _{Clock}	50	69.3	80	MHz	
	Period	T _V	776	803	1023		
Vertical Section	Active	T _{VD}		768		T_Line	
	Blanking	T _{VB}	8	35	255		
	Period	T _H	1396	1436	2047		
Horizontal	Active	T _{HD}		1366		T_{Clock}	
Section	Blanking	T _{HB}	40	70	681		

Note: DE mode only

6.4.2 Timing diagram

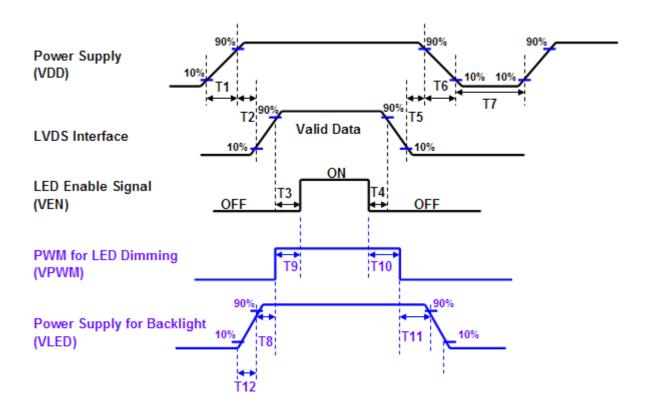




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6.5 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals and LED on/off sequence are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off



	Power Sequence Timing							
	Value							
Parameter	Min.	Тур.	Max.	Units				
T1	0.5	-	10					
T2	0	-	50					
Т3	200	-	-					
T4	200	-	-					
T5	10	-	50					
Т6	0	-	10	ms				
T7	500	-	-	1113				
Т8	10	-	-					
Т9	10	-	180					
T10	10	-	180					
T11	10	-	-					
T12	0.5	-	10					



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LSD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

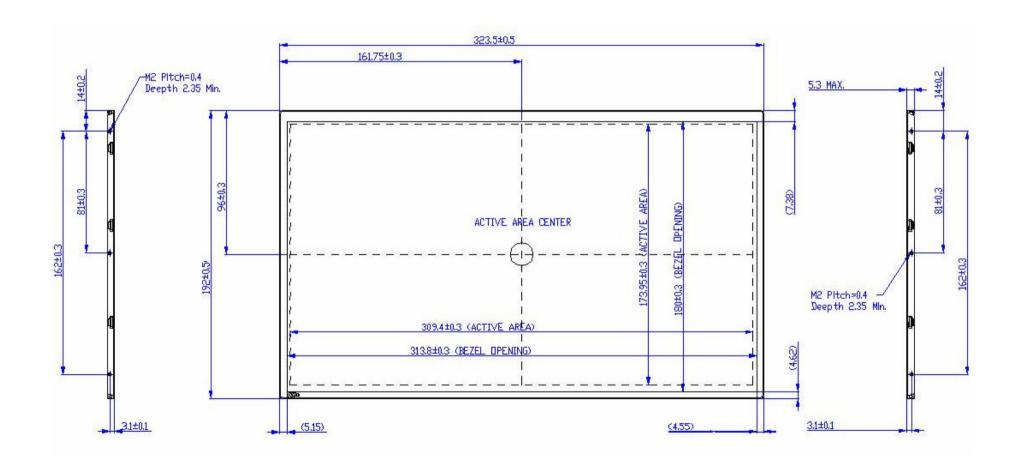
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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8. Mechanical Characteristics

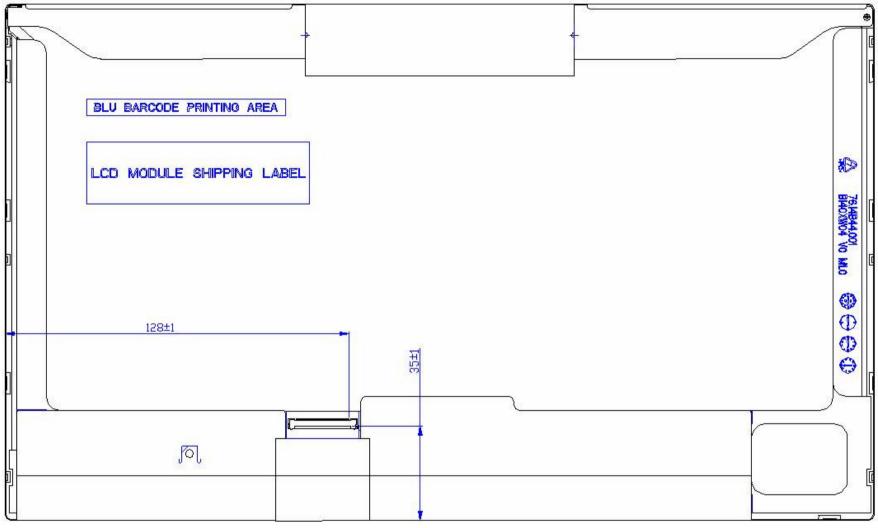
8.1 LCM Outline Dimension



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Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

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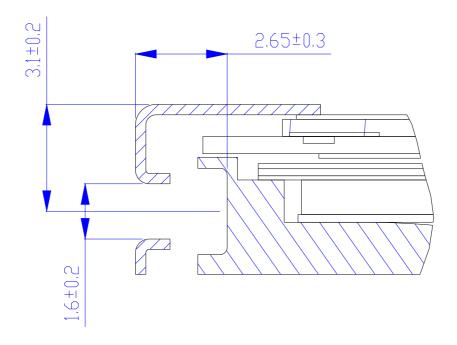


8.2 Screw Hole Depth and Center Position

Maximum Screw penetration from side surface is 2.3 mm

The center of screw hole center location is 3.1 \pm 0.2mm from front surface

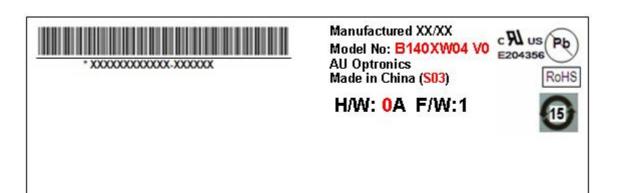
Screw Torque: Maximum 2.5 kgf-cm





9. Shipping and Package

9.1 Shipping Label Format



QTY: 25

RoHS

AU Optronics MODEL NO: B140XW04 V0

PART NO: 97.14B44.000

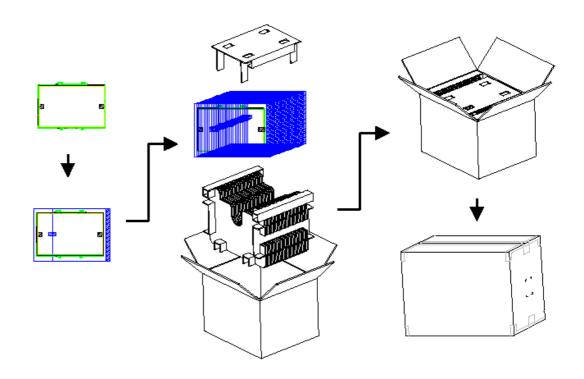
CUSTOMER NO:

CARTON NO:

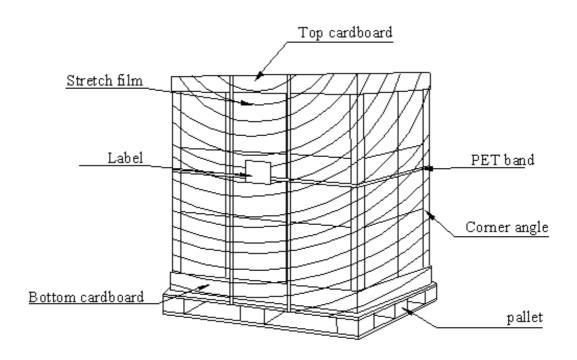
Made in China *ZM100-0652300205*



The outside dimension of carton is 454 (L)mm x 376 (W)mm x 302 (H)mm



9.3 Shipping Package of Palletizing Sequence





10. Appendix: EDID Description

TBD